- 2-V to 6-V $V_{C C}$ Operation
- High-Current 3-State Parallel Register Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80- $\mu \mathrm{A}$ Max Icc
- Typical $\mathrm{t}_{\mathrm{pd}}=14 \mathrm{~ns}$

SN54HC590A... J OR W PACKAGE
SN74HC590A... D, DW, OR N PACKAGE (TOP VIEW)


- $\pm 6-\mathrm{mA}$ Output Drive at 5 V
- Low Input Current of $1 \mu \mathrm{~A}$ Max
- 8-Bit Counter With Register
- Counter Has Direct Clear


NC - No internal connection

## description/ordering information

The 'HC590A devices contain an 8-bit binary counter that feeds an 8-bit storage register. The storage register has parallel outputs. Separate clocks are provided for both the binary counter and storage register. The binary counter features direct clear ( $\overline{\mathrm{CCLR}}$ ) and count-enable ( $\overline{\mathrm{CCKEN}}$ ) inputs. A ripple-carry output ( RCO ) is provided for cascading. Expansion is accomplished easily for two stages by connecting RCO of the first stage to $\overline{\text { CCKEN }}$ of the second stage. Cascading for larger count chains can be accomplished by connecting RCO of each stage to the counter clock (CCLK) input of the following stage.
CCLK and the register clock (RCLK) inputs are positive-edge triggered. If both clocks are connected together, the counter state always is one count ahead of the register. Internal circuitry prevents clocking from the clock enable.

ORDERING INFORMATION

| $\mathrm{T}_{\mathrm{A}}$ | PACKAGE $\dagger$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | PDIP - N | Tube of 25 | SN74HC590AN | SN74HC590AN |
|  | SOIC - D | Tube of 40 | SN74HC590AD | HC590A |
|  |  | Reel of 2500 | SN74HC590ADR |  |
|  |  | Reel of 250 | SN74HC590ADT |  |
|  | SOIC - DW | Tube of 40 | SN74HC590ADW | HC590A |
|  |  | Reel of 2000 | SN74HC590ADWR |  |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | CDIP - J | Tube of 25 | SNJ54HC590AJ | SNJ54HC590AJ |
|  | CFP - W | Tube of 150 | SNJ54HC590AW | SNJ54HC590AW |
|  | LCCC - FK | Tube of 55 | SNJ54HC590AFK | SNJ54HC590AFK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

## timing diagram



## TIMING SEQUENCE

1. Clear Counter (asynchronous).
2. Count up: $0 \times 01$. Store $0 \times 00$ in register.
3. Inhibit counter clock ( $\overline{\mathrm{CCKEN}}=\mathrm{HIGH})$. Store $0 \times 01$ in register.
4. Count $0 \times 02,0 \times 03$.
5. 3-state the outputs
6. Count up: $0 \times 04$
7. Enable outputs.
8. Continue up: $0 \times 05$
9. Store $0 \times 05$ in register.
10. Continue counting: $0 x 06 \ldots 0 x F D, 0 x F E, 0 x F F, 0 x 00$, etc.
11. Store $0 \times 00$ in register.
logic diagram (positive logic)


Pin numbers shown are for the D, DW, J, N, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$

$$
\text { Supply voltage range, } \mathrm{V}_{\mathrm{CC}} \text {. .................................................................................. . . } 0.5 \mathrm{~V} \text { to } 7 \mathrm{~V}
$$

Input clamp current, $\mathrm{I}_{\mathrm{IK}}\left(\mathrm{V}_{1}<0\right.$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{CC}}$ ) (see Note 1) ........................................ $\pm 20 \mathrm{~mA}$
Output clamp current, $\mathrm{I}_{\mathrm{OK}}\left(\mathrm{V}_{\mathrm{O}}<0\right.$ or $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{CC}}$ ) (see Note 1) ..................................... 20 mA

Continuous current through $\mathrm{V}_{\mathrm{CC}}$ or GND .......................................................... $\pm 70 \mathrm{~mA}$
Package thermal impedance, $\theta_{\mathrm{JA}}$ (see Note 2): D package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $73^{\circ} \mathrm{C} / \mathrm{W}$
DW package ....................................... $57^{\circ} \mathrm{C} / \mathrm{W}$
N package ............................................ $67^{\circ} \mathrm{C} / \mathrm{W}$

$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.
recommended operating conditions (see Note 3)

|  |  |  | SN54HC590A |  |  | SN74HC590A |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 2 | 5 | 6 | 2 | 5 | 6 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ | 1.5 |  |  | 1.5 |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.15 |  |  | 3.15 |  |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6 \mathrm{~V}$ | 4.2 |  |  | 4.2 |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 0.5 |  |  | 0.5 |  |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  | 1.35 |  |  | 1.35 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6 \mathrm{~V}$ |  |  | 1.8 |  |  | 1.8 |  |
| $\mathrm{V}_{1}$ | Input voltage |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 1000 |  |  | 1000 |  |
| $\mathrm{t}_{\mathrm{t}} \ddagger$ | Input transition (rise and fall) time | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  | 500 |  |  | 500 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6 \mathrm{~V}$ |  |  | 400 |  |  | 400 |  |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature |  | -55 |  | 125 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

$\ddagger$ If this device is used in the threshold region (from $\mathrm{V}_{I \mathrm{~L}} \max =0.5 \mathrm{~V}$ to $\mathrm{V}_{\text {IH }} \min =1.5 \mathrm{~V}$ ), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at $t_{t}=1000 \mathrm{~ns}$ and $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ does not damage the device; however, functionally, the CCLK and RCLK inputs are not ensured while in the shift, count, or toggle operating modes.
NOTE 3: All unused inputs of the device must be held at $\mathrm{V}_{\mathrm{CC}}$ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | SN54HC590A |  | SN74HC590A |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ | $\mathrm{l} \mathrm{OH}=-20 \mu \mathrm{~A}$ |  | 2 V | 1.9 | 1.998 |  | 1.9 |  | 1.9 |  | V |
|  |  |  | 4.5 V | 4.4 | 4.499 |  | 4.4 |  | 4.4 |  |  |  |
|  |  |  | 6 V | 5.9 | 5.999 |  | 5.9 |  | 5.9 |  |  |  |
|  |  | $\overline{\mathrm{RCO}}, \mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA}$ | 4.5 V | 3.98 | 4.3 |  | 3.7 |  | 3.84 |  |  |  |
|  |  | $\mathrm{Q}_{\mathrm{A}}-\mathrm{Q}_{\mathrm{H}}, \mathrm{l}_{\mathrm{OH}}=-6 \mathrm{~mA}$ |  | 3.98 | 4.3 |  | 3.7 |  | 3.84 |  |  |  |
|  |  | $\overline{\mathrm{RCO}}, \mathrm{I} \mathrm{OH}=-5.2 \mathrm{~mA}$ | 6 V | 5.48 | 5.8 |  | 5.2 |  | 5.34 |  |  |  |
|  |  | $\mathrm{Q}_{\mathrm{A}}-\mathrm{Q}_{\mathrm{H}}, \mathrm{IOH}=-7.8 \mathrm{~mA}$ |  | 5.48 | 5.8 |  | 5.2 |  | 5.34 |  |  |  |
| VOL | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ | $\mathrm{l} \mathrm{OL}=20 \mu \mathrm{~A}$ | 2 V |  | 0.002 | 0.1 |  | 0.1 |  | 0.1 | V |  |
|  |  |  | 4.5 V |  | 0.001 | 0.1 |  | 0.1 |  | 0.1 |  |  |
|  |  |  | 6 V |  | 0.001 | 0.1 |  | 0.1 |  | 0.1 |  |  |
|  |  | RCO, $\mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA}$ | 4.5 V |  | 0.17 | 0.26 |  | 0.4 |  | 0.33 |  |  |
|  |  | $\mathrm{Q}_{\mathrm{A}}-\mathrm{Q}_{\mathrm{H}}, \mathrm{l}_{\mathrm{OL}}=6 \mathrm{~mA}$ |  |  | 0.17 | 0.26 |  | 0.4 |  | 0.33 |  |  |
|  |  | $\overline{\mathrm{RCO}}, \mathrm{I} \mathrm{OL}=5.2 \mathrm{~mA}$ | 6 V |  | 0.15 | 0.26 |  | 0.4 |  | 0.33 |  |  |
|  |  | $\mathrm{Q}_{\mathrm{A}} \mathrm{Q}_{\mathrm{H}}, \mathrm{l} \mathrm{IL}=7.8 \mathrm{~mA}$ |  |  | 0.15 | 0.26 |  | 0.4 |  | 0.33 |  |  |
| I | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CC }}$ or 0 |  | 6 V |  | $\pm 0.1$ | $\pm 100$ |  | $\pm 1000$ |  | $\pm 1000$ | nA |  |
| IOZ | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or 0 |  | 6 V |  | $\pm 0.01$ | $\pm 0.5$ |  | $\pm 10$ |  | $\pm 5$ | $\mu \mathrm{A}$ |  |
| ICC | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CC }}$ or 0 , | $\mathrm{O}=0$ | 6 V |  |  | 8 |  | 160 |  | 80 | $\mu \mathrm{A}$ |  |
| $\mathrm{C}_{\mathrm{i}}$ |  |  | $\begin{gathered} 2 \mathrm{~V} \\ \text { to } 6 \mathrm{~V} \end{gathered}$ |  | 3 | 10 |  | 10 |  | 10 | pF |  |

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

|  |  |  | VCC | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | SN54HC590A | SN74HC590A | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN MAX | MIN MAX | MIN MAX |  |
| ${ }^{\text {f }}$ lock | Clock frequency |  |  | 2 V | 4 | 2.5 | 3.2 | MHz |
|  |  |  | 4.5 V | 20 | 13 | 16 |  |  |
|  |  |  | 6 V | 24 | 16 | 19 |  |  |
| $t_{w}$ | Pulse duration | CCLK or RCLK high or low | 2 V | 125 | 200 | 155 | ns |  |
|  |  |  | 4.5 V | 25 | 38 | 31 |  |  |
|  |  |  | 6 V | 21 | 32 | 26 |  |  |
|  |  | $\overline{\text { CCLR }}$ low | 2 V | 100 | 150 | 125 |  |  |
|  |  |  | 4.5 V | 20 | 30 | 25 |  |  |
|  |  |  | 6 V | 17 | 26 | 21 |  |  |
| $\mathrm{t}_{\text {su }}$ | Setup time | $\overline{\text { CCKEN }}$ low before CCLK $\uparrow$ | 2 V | 100 | 150 | 125 | ns |  |
|  |  |  | 4.5 V | 20 | 30 | 25 |  |  |
|  |  |  | 6 V | 17 | 26 | 21 |  |  |
|  |  | $\overline{\text { CCLR }}$ high (inactive) before CCLK $\uparrow$ | 2 V | 100 | 150 | 125 |  |  |
|  |  |  | 4.5 V | 20 | 30 | 25 |  |  |
|  |  |  | 6 V | 17 | 26 | 21 |  |  |
|  |  | CCLK $\uparrow$ before RCLK $\uparrow \uparrow$ | 2 V | 100 | 150 | 125 |  |  |
|  |  |  | 4.5 V | 20 | 30 | 25 |  |  |
|  |  |  | 6 V | 17 | 26 | 21 |  |  |
| th | Hold time | $\overline{\text { CCKEN }}$ low after CCLK $\uparrow$ | 2 V | 50 | 75 | 60 | ns |  |
|  |  |  | 4.5 V | 10 | 15 | 12 |  |  |
|  |  |  | 6 V | 9 | 13 | 11 |  |  |

$\dagger$ This setup time ensures that the register gets stable data from the counter outputs. The clocks may be tied together, in which case the register is one clock pulse behind the counter.
switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)


* This parameter is not production tested for the SN54HC590A.
switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $\mathrm{V}_{\mathrm{cc}}$ | SN74HC590A |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | MIN MAX |  |
|  |  |  |  | MIN TYP | MAX |  |  |
| $f_{\text {max }}$ |  |  | 2 V | 48 |  | 3.2 | MHz |
|  |  |  | 4.5 V | 2035 |  | 16 |  |
|  |  |  | 6 V | 2440 |  | 19 |  |
| $t_{\text {pd }}$ | CCLK $\uparrow$ | $\overline{\mathrm{RCO}}$ | 2 V | 80 | 150 | 190 | ns |
|  |  |  | 4.5 V | 20 | 30 | 38 |  |
|  |  |  | 6 V | 15 | 26 | 33 |  |
| tPLH | $\overline{\text { CCLR }} \downarrow$ | $\overline{\mathrm{RCO}}$ | 2 V | 70 | 130 | 165 | ns |
|  |  |  | 4.5 V | 18 | 26 | 33 |  |
|  |  |  | 6 V | 14 | 22 | 28 |  |
| $t_{\text {pd }}$ | RCLK $\uparrow$ | Q | 2 V | 70 | 140 | 175 | ns |
|  |  |  | 4.5 V | 18 | 28 | 35 |  |
|  |  |  | 6 V | 14 | 24 | 30 |  |
| ten | $\overline{\mathrm{OE}} \downarrow$ | Q | 2 V | 80 | 125 | 155 | ns |
|  |  |  | 4.5 V | 20 | 25 | 31 |  |
|  |  |  | 6 V | 15 | 21 | 26 |  |
| $t_{\text {dis }}$ | $\overline{\mathrm{OE}} \uparrow$ | Q | 2 V | 80 | 125 | 155 | ns |
|  |  |  | 4.5 V | 20 | 25 | 31 |  |
|  |  |  | 6 V | 15 | 21 | 26 |  |
| $t_{t}$ |  | $\overline{\text { RCO }}$ | 2 V | 38 | 75 | 95 | ns |
|  |  |  | 4.5 V | 8 | 15 | 19 |  |
|  |  |  | 6 V | 6 | 13 | 16 |  |
|  |  | Q | 2 V | 38 | 60 | 75 |  |
|  |  |  | 4.5 V | 8 | 12 | 15 |  |
|  |  |  | 6 V | 6 | 10 | 13 |  |

switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=150 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | Vcc | SN54HC590A |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | MIN | MAX |  |
|  |  |  |  | MIN | TYP | MAX |  |  |  |
| ${ }^{\text {tpd }}$ | RCLK $\uparrow$ | Q | 2 V |  | 100 | 300 |  | 447 | ns |
|  |  |  | 4.5 V |  | 24 | 60 |  | 90 |  |
|  |  |  | 6 V |  | 20 | 51 |  | 77 |  |
| $t_{\text {en }}$ | $\overline{O E}$ | Q | 2 V |  | 90 | 200 |  | 300 | ns |
|  |  |  | 4.5 V |  | 23 | 40 |  | 60 |  |
|  |  |  | 6 V |  | 19 | 34 |  | 51 |  |
| $t_{t}{ }^{*}$ |  | Q | 2 V |  | 45 | 210 |  | 315 | ns |
|  |  |  | 4.5 V |  | 17 | 42 |  | 63 |  |
|  |  |  | 6 V |  | 13 | 36 |  | 53 |  |

* This parameter is not production tested for the SN54HC590A.
switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=150 \mathrm{pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | $\begin{gathered} \text { TO } \\ \text { (OUTPUT) } \end{gathered}$ | Vcc | SN74HC590A |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | MIN | MAX |  |
|  |  |  |  | MIN | TYP | MAX |  |  |  |
| ${ }^{\text {tpd }}$ | RCLK $\uparrow$ | Q | 2 V |  | 100 | 300 |  | 380 | ns |
|  |  |  | 4.5 V |  | 24 | 60 |  | 76 |  |
|  |  |  | 6 V |  | 20 | 51 |  | 65 |  |
| ten | $\overline{\mathrm{OE}}$ | Q | 2 V |  | 90 | 200 |  | 250 | ns |
|  |  |  | 4.5 V |  | 23 | 40 |  | 50 |  |
|  |  |  | 6 V |  | 19 | 34 |  | 43 |  |
| $t_{t}$ |  | Q | 2 V |  | 45 | 210 |  | 265 | ns |
|  |  |  | 4.5 V |  | 17 | 42 |  | 53 |  |
|  |  |  | 6 V |  | 13 | 36 |  | 45 |  |

operating characteristics, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
| :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{pd}}$ Power dissipation capacitance | No load | 250 | pF |

## PARAMETER MEASUREMENT INFORMATION



| PARAMETER |  | RL | $\mathrm{C}_{\mathrm{L}}$ | S1 | S2 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ten | tPZH | $1 \mathrm{k} \Omega$ | $\begin{gathered} 50 \mathrm{pF} \\ \text { or } \\ 150 \mathrm{pF} \end{gathered}$ | Open | Closed |
|  | tPZL |  |  | Closed | Open |
| ${ }^{\text {dis }}$ | tPHZ | $1 \mathrm{k} \Omega$ | 50 pF | Open | Closed |
|  | tpLZ |  |  | Closed | Open |
| ${ }_{t p d}$ or $t_{t}$ |  | -- | $\begin{gathered} 50 \mathrm{pF} \\ \text { or } \\ 150 \mathrm{pF} \end{gathered}$ | Open | Open |



VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES


NOTES: A. $C_{L}$ includes probe and test-fixture capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}}=6 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns}$.
D. The outputs are measured one at a time with one input transition per measurement.
E. $t_{P L Z}$ and $t_{P H Z}$ are the same as $t_{\text {dis }}$.
F. $t_{P Z L}$ and $t_{P Z H}$ are the same as ten.
G. $\quad \mathrm{tPLH}$ and $\mathrm{t}_{\mathrm{PHL}}$ are the same as $\mathrm{t}_{\mathrm{pd}}$.

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing | Pins | Package Qty | $\text { e Eco Plan }{ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5962-89603012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| 5962-8960301EA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 5962-8960301FA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type |
| SN54HC590AJ | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| SN74HC590AD | ACTIVE | SOIC | D | 16 | 40 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br})$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADRE4 | ACTIVE | SOIC | D | 16 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADRG4 | ACTIVE | SOIC | D | 16 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADT | ACTIVE | SOIC | D | 16 | 250 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADTE4 | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS \& no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADTG4 | ACTIVE | SOIC | D | 16 | 250 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADW | ACTIVE | SOIC | DW | 16 | 40 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADWG4 | ACTIVE | SOIC | DW | 16 | 40 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADWR | ACTIVE | SOIC | DW | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590ADWRG4 | ACTIVE | SOIC | DW | 16 | 2000 | $\begin{aligned} & \text { Green (RoHS \& } \\ & \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{aligned}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SN74HC590AN | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SN74HC590AN3 | OBSOLETE | PDIP | N | 16 |  | TBD | Call TI | Call TI |
| SN74HC590ANE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SNJ54HC590AFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N/ A for Pkg Type |
| SNJ54HC590AJ | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N/A for Pkg Type |
| SNJ54HC590AW | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N/ A for Pkg Type |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[^0]$\mathrm{Pb}-\mathrm{Free}$ (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb -Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no $\mathbf{S b} / \mathrm{Br}$ ): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 $(\mathbf{m m})$ | A0 (mm) | B0 (mm) | K0 (mm) | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74HC590ADR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74HC590ADWR | SOIC | DW | 16 | 2000 | 330.0 | 16.4 | 10.75 | 10.7 | 2.7 | 12.0 | 16.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN74HC590ADR | SOIC | D | 16 | 2500 | 333.2 | 345.9 | 28.6 |
| SN74HC590ADWR | SOIC | DW | 16 | 2000 | 346.0 | 346.0 | 33.0 |

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004


| DIM PINS ** | 14 | 16 | 18 | 20 |
| :---: | :---: | :---: | :---: | :---: |
| A | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC |
| B MAX | 0.785 <br> $(19,94)$ | .840 <br> $(21,34)$ | 0.960 <br> $(24,38)$ | 1.060 <br> $(26,92)$ |
| B MIN | - | - | - | - |
| C MAX | 0.300 <br> $(7,62)$ | 0.300 <br> $(7,62)$ | 0.310 <br> $(7,87)$ | 0.300 <br> $(7,62)$ |
| C MIN | 0.245 <br> $(6,22)$ | 0.245 <br> $(6,22)$ | 0.220 <br> $(5,59)$ | 0.245 <br> $(6,22)$ |



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

D (R-PDSO-G16)
PLASTIC SMALL-OUTLINE PACKAGE


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed $.006(0,15)$ per end.
D Body width does not include interlead flash. Interlead flash shall not exceed $.017(0,43)$ per side.
E. Reference JEDEC MS-012 variation AC.

## D(R-PDSO-G16)



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Refer to IPC7351 for alternate board design.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DW (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-013 variation AA.

N (R-PDIP-T**)
PLASTIC DUAL-IN-LINE PACKAGE
16 PINS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C) Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D The 20 pin end lead shoulder width is a vendor option, either half or full width.

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[^0]:    ${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
    TBD: The Pb-Free/Green conversion plan has not been defined.

